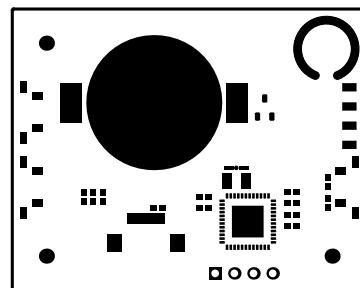
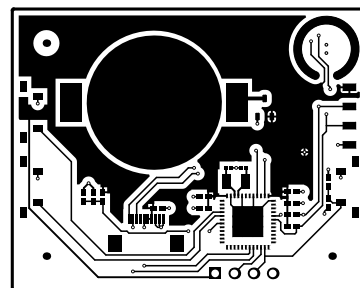


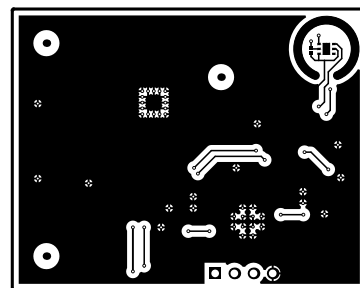
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01626		
PLOT NAME = Top Overlay	GENERATED : 4/30/2018 2:33:16 PM	TEXAS INSTRUMENTS	



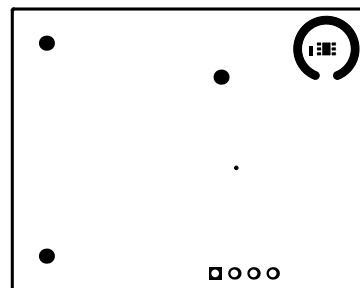
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01626		
PLOT NAME = Top Solder Mask	GENERATED : 4/30/2018 2:33:17 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01626		
PLOT NAME = Top Layer	GENERATED : 4/30/2018 2:33:18 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01626		
PLOT NAME = Bottom Layer	GENERATED : 4/30/2018 2:33:18 PM	TEXAS INSTRUMENTS	

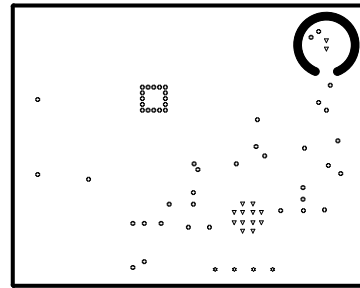


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01626		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/30/2018 2:33:19 PM	TEXAS INSTRUMENTS	

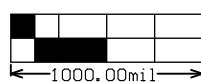
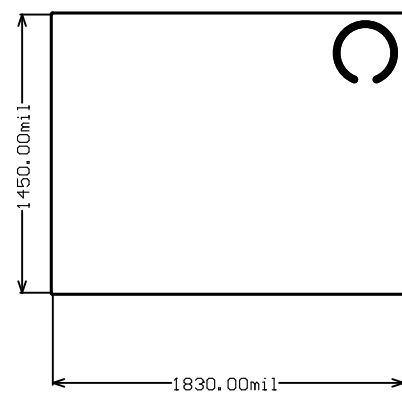


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01626		
PLOT NAME = Bottom Overlay	GENERATED : 4/30/2018 2:33:20 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
▽	14	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	49	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	
⊛	4	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
	67 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01626		
PLOT NAME = Drill Drawing	GENERATED : 4/30/2018 2:33:21 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SENS021	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01626		
PLOT NAME = Board Dimensions	GENERATED : 4/30/2018 2:33:22 PM	TEXAS INSTRUMENTS	

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